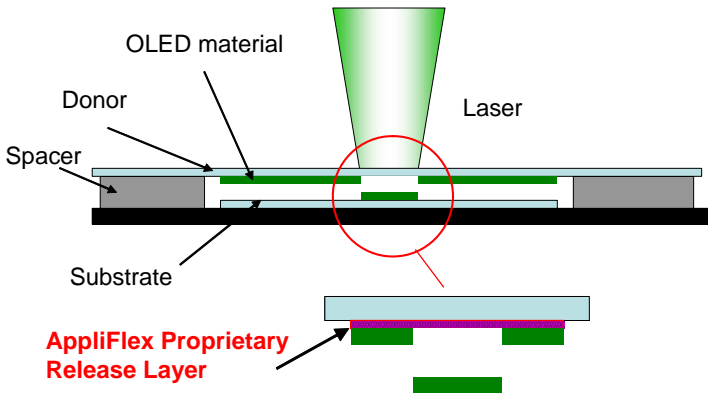


Advanced Release Layer For Laser Transfer & Printing

Engineered materials for damage-free laser transfer process

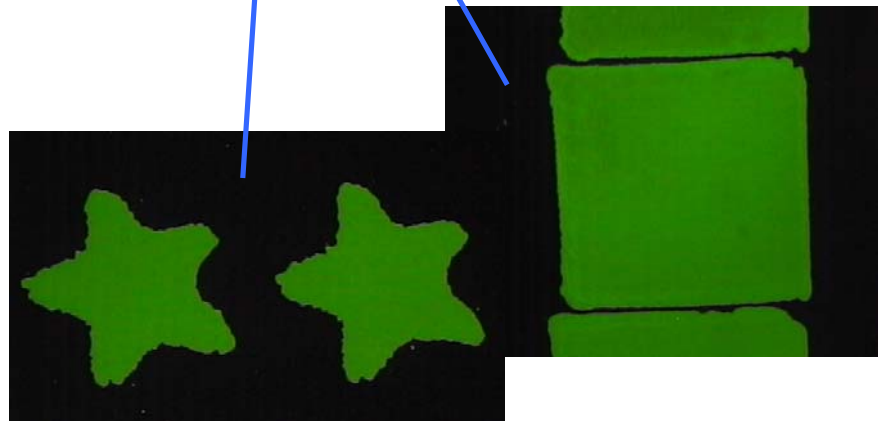
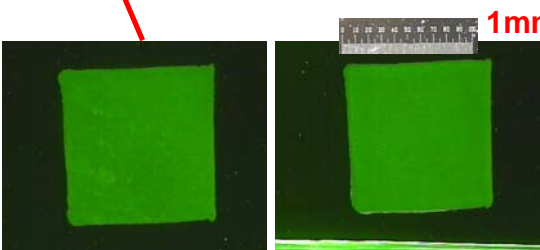
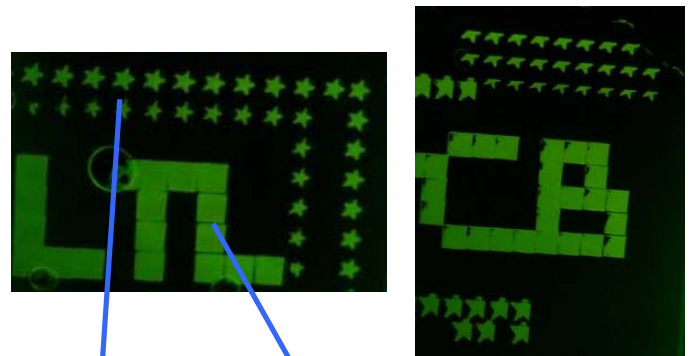
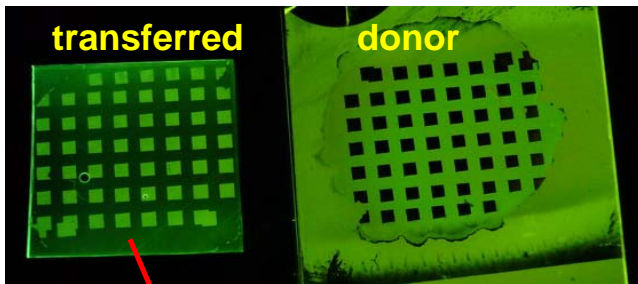


Features

Localized and Efficient Laser Coupling by engineering the laser – materials interaction, substantially reducing the laser power requirement.

Damage-Free Process enabled by tuning, optimizing and matching of laser properties and release layer materials properties.

Nanotechnology based materials engineering for the release layer.



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